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DATA SHEET

SKY73032-11: 700 – 1000 MHz High Gain and Linearity Single Downconversion Mixer

Applications

- 2G/3G base station transceivers:
 - GSM/EDGE, CDMA, UMTS/WCDMA, iDEN
- · Land mobile radio
- ISM band transceivers
- · High performance radio links
- RF identification

Features

. Operating frequency range: 700 to 1000 MHz

• IF frequency range: 40 to 300 MHz

Conversion gain: 9.5 dBInput IP3: +27.0 dBmOutput IP3: +36.5 dBm

Noise figure: 8.3 dBIntegrated LO drivers

- Integrated low loss RF baluns
- · High linearity IF amplifiers
- On-chip SPDT LO switch (greater than 40 dB LO-to-LO isolation)
- Small, MCM (20-pin, 5 x 5 mm) Pb-free package (MSL3, 260 °C per JEDEC J-STD-020)



Skyworks offers lead (Pb)-free RoHS (Restriction of Hazardous Substances) compliant packaging.

Description

The SKY73032-11 is a fully integrated single mixer that includes Local Oscillator (LO) drivers, an LO switch, high linearity mixers, and large dynamic range Intermediate Frequency (IF) amplifiers. Low loss RF baluns have also been included to reduce design complications and lower system cost.

The SKY73032-11 features an input IP3 of \pm 27.0 dBm and a Noise Figure (NF) of 8.3 dB, making the device an ideal solution for high dynamic range systems such as 2G/3G base station transceivers. The LO switch provides more than 40 dB of isolation between LO inputs and supports the switching time required for GSM/EDGE base stations.

The SKY73032-11 is manufactured using a robust silicon BiCMOS process and has been designed for optimum long-term reliability. The SKY73032-11 single downconversion mixer is provided in a compact, 20-pin 5 x 5 mm Multi-Chip Module (MCM). A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

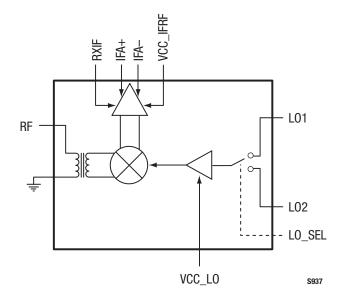


Figure 1. SKY73032-11 Block Diagram

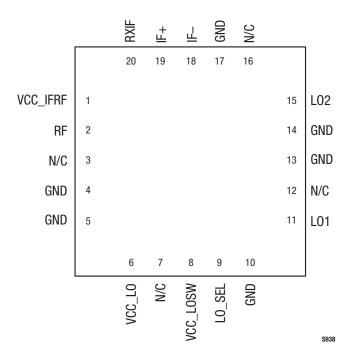


Figure 2. SKY73032-11 Pinout – 20-Pin MCM

Table 1. SKY73032-11 Signal Descriptions

| Pin# | Name | Description | Pin # | Name | Description | |
|------|----------|--------------------------|-------|------|--------------------|--|
| 1 | VCC_IFRF | IF and RF DC supply, +5V | 11 | L01 | LO1 input | |
| 2 | RF | RF input | 12 | N/C | No connection | |
| 3 | N/C | No connection | 13 | GND | Ground | |
| 4 | GND | Ground | 14 | GND | Ground | |
| 5 | GND | Ground | 15 | L02 | LO2 input | |
| 6 | VCC_LO | LO DC supply, +5V | 16 | N/C | No connection | |
| 7 | N/C | No connection | 17 | GND | Ground | |
| 8 | VCC_LOSW | LO switch DC supply, +5V | 18 | IF- | Negative IF output | |
| 9 | LO_SEL | LO select switch control | 19 | IF+ | Positive IF output | |
| 10 | GND | Ground | 20 | RXIF | IF bias adjust | |

Functional Description

The SKY73032-11 is a high gain single mixer, optimized for base station receiver applications. The device consists of a low loss RF balun, high linearity passive mixer, and a low noise IF amplifier.

An LO amplifier is also included that allow the SKY73032-11 to connect directly to the output of a Voltage Controlled Oscillator (VCO). This eliminates the extra gain stages needed by most discrete passive mixers. A Single Pole, Double Throw (SPDT) switch has been included to select between two different LO inputs (LO1 and LO2) for frequency hopping applications such as GSM.

RF Baluns and Passive Mixer

The RF baluns provide a single ended input, which can easily be matched to 50 Ω using a simple external matching circuit. The RF baluns offer very low loss, and excellent amplitude and phase balance.

The high linearity SKY73032-11 is a passive, double balanced mixer that provides a very low conversion loss, and excellent 3rd Order Input Insertion Point (IIP3).

Addtionally, the balanced nature of the mixer provides for high port-to-port isolation.

LO Buffers and SPDT LO Switch

The LO buffers allow the input power of the SKY73032-11 to be in the range of ± 6 dBm. The LO section is optimized for high-side LO injection. However, each of the two LOs can be driven over a wide frequency range with only slight degradation in performance.

A high isolation SPDT switch allows the SKY73032-11 to be used for frequency hopping applications. This switch provides greater than 40 dB of LO1 to LO2 isolation:

| LO_SEL Input | LO Path Selected |
|--------------|----------------------|
| High | L01 (pin 11) enabled |
| Low | LO2 (pin 15) enabled |

For applications that do not require frequency hopping, LO_SEL is fixed to one state and the appropriate LO input is used. An internal pull-down resistor enables the LO2 input.

IF Amplifier

The SKY73032-11 includes high dynamic range IF amplifiers that follow the passive mixers in the signal path. The outputs require a supply voltage connection using inductive chokes. These choke inductors should be high-Q and have the ability to handle 200 mA or greater.

A simple matching network allows the output ports to be matched to a balanced 200 Ω impedance. The IF amplifiers are optimized for IF frequencies between 40 and 300 MHz. The IF amplifiers can be operated outside of this range, but with a slight degradation in performance.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY73032-11 are provided in Table 2 and the recommended operating conditions in Table 3. Electrical characteristics for the SKY73032-11 are provided in Table 4.

Typical performance characteristics for the SKY73032-11 are illustrated in Figures 3 through 19.

Table 2. SKY73032-11 Absolute Maximum Ratings (Note 1)

| Parameter | Symbol | Minimum | Maximum | Units |
|-------------------------------|--------|---------|---------|-------|
| Supply voltage, +5 V | VCC | 4.5 | 5.5 | V |
| Supply current | Icc | | 240 | mA |
| RF input power | Prf | | +20.0 | dBm |
| L0 input power | PLO | | +20.0 | dBm |
| Operating case temperature | Tc | -40 | +85 | °C |
| Junction temperature (Note 2) | TJ | | +150 | °C |
| Storage case temperature | Тѕтс | -40 | +125 | °C |

Note 1: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

CAUTION: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

Table 3. SKY73032-11 Recommended Operating Conditions

| Parameter | Symbol | Minimum | Typical | Maximum | Units |
|---------------------------------|--------------------|---------|---------|---------|--------|
| Supply voltage, +5 V | VCC | 4.75 | 5.00 | 5.25 | ٧ |
| Supply current | Icc | | 210 | | mA |
| LO input power | PLO | -6.0 | 0 | +6.0 | dBm |
| LO select input: high low | LO_SELH LO_SELL | 2.2 | | 0.8 | V V |
| Operating case temperature | Tc | -40 | | +85 | °C |
| RF frequency range | FRF | 700 | | 1000 | MHz |
| LO frequency range (Note 1) | FLO | 900 | | 1250 | MHz |
| IF frequency range | Fif | 40 | | 300 | MHz |

Note 1: The SKY73032-11 has been optimized for high side L0 injection. However, the L0 can be used outside of the specified frequency range with degraded performance.

Note 2: Nominal thermal resistance (junction to center ground pad) is 5.1 $^{\circ}$ C/W.

Table 4. SKY73032-11 Electrical Specifications (Note 1) (VCC = +5 V, $T_A = +25$ °C, LO = 0 dBm, RF Frequency = 900 MHz, IF Frequency = 200 MHz, LO Frequency = 1100 MHz, Unless Otherwise Noted)

| Parameter | Symbol | Test Condition | Min | Typical | Max | Units |
|---|---------|--|-------|------------|------------|------------|
| Conversion gain | G | $f_{RF} = 824 \text{ to } 915 \text{ MHz},$ $T_A = 25 ^{\circ}\text{C}, P_{L0} = -3 \text{ to}$ +3 dBm | 8.2 | 9.5 | | dB |
| Gain variation over temperature | | T _A = −40 to +85 °C | | ±0.6 | | dB |
| Noise Figure | NF | T _A = 25 °C, P _{L0} = -3 to +3 dBm, VCC = 4.75 to 5.25 V, IF = 200 MHz | | 8.3 | | dB |
| Noise Figure variation over temperature | | T _A = −40 to +85 °C | | ±0.8 | | dB |
| Noise Figure with a blocker signal | NFBLK | Blocking signal input power = +8 dBm | | 18 | | dB |
| Third order input intercept point | IIP3 | fr= 900 MHz and 900.8 MHz, Pr= -10 dBm/tone, VCC = 4.75 to 5.25 V | +24.7 | +27.0 | | dBm |
| Input IP3 variation over temperature | | $T_A = -40 \text{ to } +85 ^{\circ}\text{C}$ | | ±0.3 | | dB |
| Third order output intercept point | OIP3 | fr= 900 MHz and 900.8 MHz, Pr= -10 dBm/tone, VCC = 4.75 to 5.25 V | | +36.5 | | dBm |
| 2RF - 2L0 | 2x2 | PRF = −10 dBm | | -68.5 | -63 | dBc |
| 3RF – 3L0 | 3x3 | PRF = −10 dBm | | -80 | -70 | dBc |
| Input 1 dB compression point | IP1dB | | +11.0 | +13.3 | | dBm |
| Output 1 dB compression point | OP1dB | | | +22.8 | | dBm |
| L01-to-L02 isolation | | | | 40 | | dB |
| RF to IF isolation | | | 38 | 48 | | dB |
| LO leakage: @ RF port @ IF port | | | | -59 -34 | -42 -23 | dBm dBm |
| RF port input return loss | ZIN_RF | With external matching components | 14 | | | dB |
| LO port input return loss | ZIN_LO | With external matching components | 14 | | | dB |
| IF port output return loss | Zout_if | With external matching components | 14 | | | dB |

Note 1: Performance is guaranteed only under the conditions listed in this Table and is not guaranteed over the full operating or storage temperature ranges. Operation at elevated temperatures may reduce reliability of the device.

DATA SHEET • SKY73032-11 DOWNCONVERSION MIXER

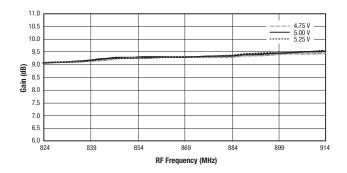


Figure 3. Gain vs Frequency and Supply Voltage

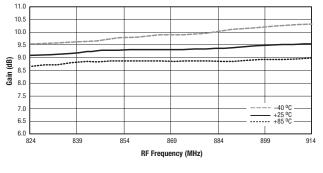


Figure 4. Gain vs Frequency and Temperature

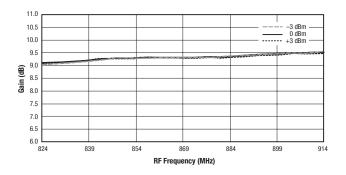


Figure 5. Gain vs Frequency and LO Power

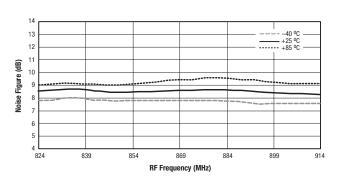


Figure 6. Noise Figure vs Frequency and Temperature

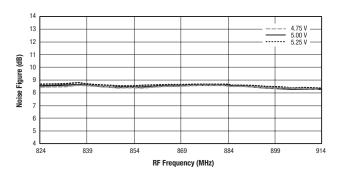


Figure 7. Noise Figure vs Frequency and Supply Voltage

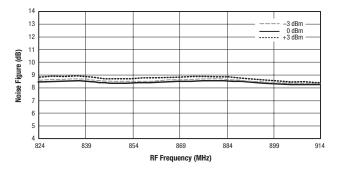


Figure 8. Noise Figure vs Frequency and LO Power

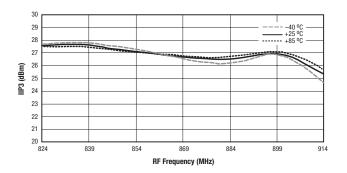


Figure 9. IIP3 vs Frequency and Temperature

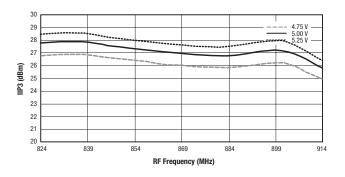


Figure 10. IIP3 vs Frequency and Supply Voltage

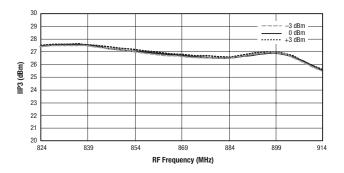


Figure 11. IIP3 vs Frequency and LO Power

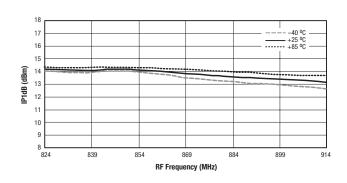


Figure 12. IP1dB vs Frequency and Temperature

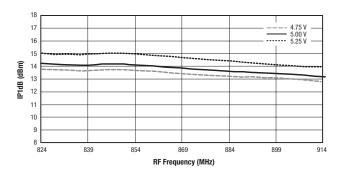


Figure 13. IP1dB vs Frequency and Supply Voltage

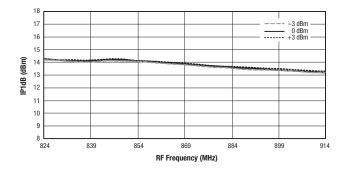


Figure 14. IP1dB vs Frequency and LO Power

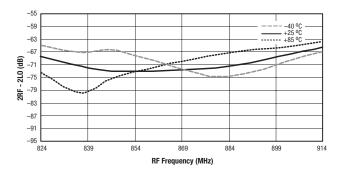


Figure 15. 2RF – 2LO vs Frequency and Temperature

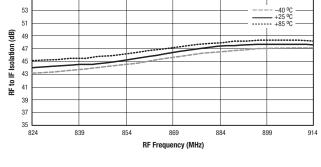


Figure 16. RF to IF Isolation vs Frequency and Temperature

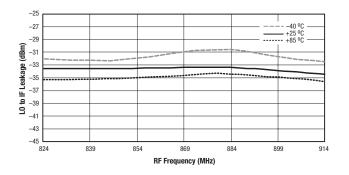


Figure 17. LO to IF Leakage vs Frequency and Temperature

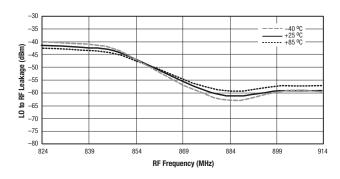


Figure 18. LO to RF Leakage vs Frequency and Temperature

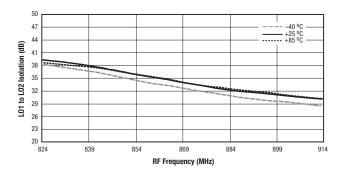


Figure 19. L01 to L02 Isolation vs Frequency and Temperature

Evaluation Board Description

The SKY73032-11 Evaluation Board is used to test the performance of the SKY73032-11 downconversion mixer. An assembly drawing for the Evaluation Board is shown in Figure 20 and the layer detail is provided in Figure 21.

Circuit Design Configurations

The following design considerations are general in nature and must be followed regardless of final use or configuration:

- 1. Paths to ground should be made as short and as low impedance as possible.
- 2. The ground pad of the SKY73032-11 provides critical electrical and thermal functionality. This pad is the main thermal conduit for heat dissipation. Since the circuit board acts as the heat sink, it must shunt as much heat as possible from the device. Therefore, design the connection to the ground pad to dissipate the maximum heat produced by the circuit board. For more information on soldering the

- SKY73032-11, refer to the Package and Handling Information section of this Data Sheet.
- 3. Skyworks recommends including external bypass capacitors on the VCC voltage inputs of the device.
- Components L5 and L4 (see Figure 22) are high-Q, low loss inductors. These inductors must be able to pass currents in excess of 200 mA DC.
- 5. Components R7 and R8 (see Figure 22) allow for external adjustment of the IF amplifier bias points. To reduce the IF amplifier bias current, connect pin 20 to ground through external resistor R8. To increase the IF amplifier bias current, connect pin 20 to VCC through external resistor R7. For operation as specified in Tables 3 and 4, these resistors are not required.

A schematic diagram for the SKY73032-11 Evaluation Board is shown in Figure 22.

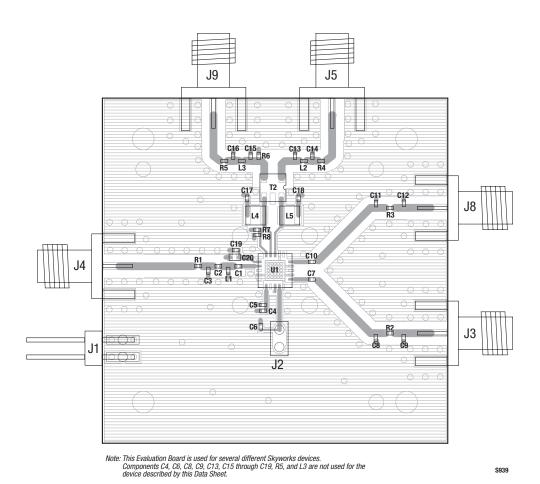
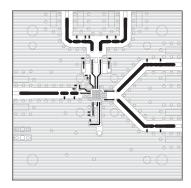


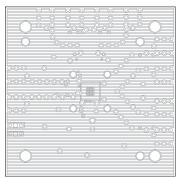
Figure 20. SKY73032-11 Evaluation Board Assembly Diagram



Layer 1: Top - Metal



Layer 2: Ground



Layer 3: Power Plane



Layer 4: Solid Ground Plane

S940

Figure 21. SKY73032-11 Evaluation Board Layer Detail

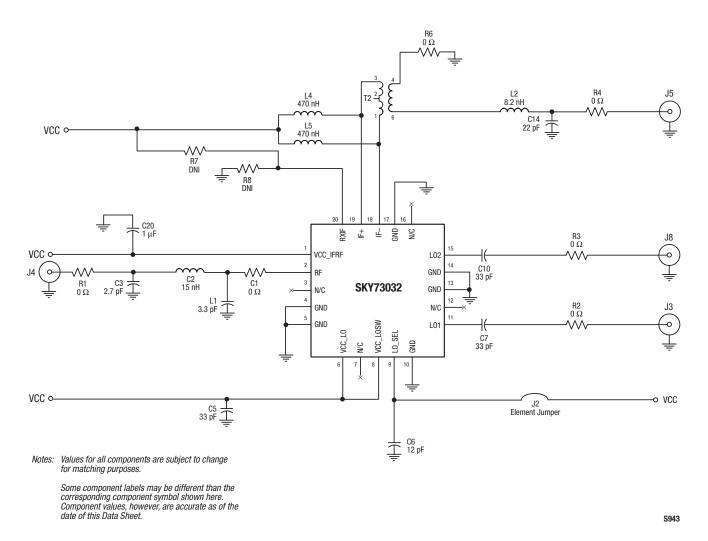


Figure 22. SKY73032-11 Evaluation Board Schematic

Package Dimensions

Figure 23 shows the package dimensions for the 20-pin MCM, and Figure 24 provides the tape and reel dimensions.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

THE SKY73032-11 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *PCB Design & SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format. For packaging details, refer to the Skyworks Application Note, *Tape and Reel*, document number 101568.

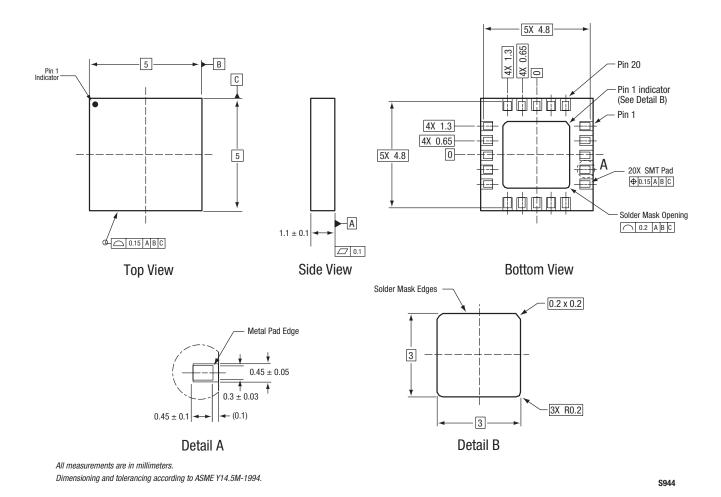


Figure 23. SKY73032-11 20-Pin MCM Package Dimensions

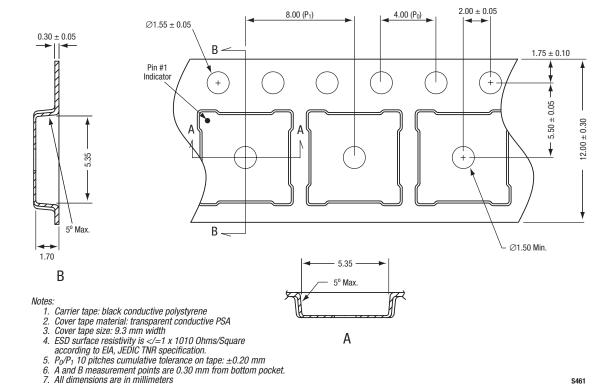


Figure 24. SKY73032-11 Tape and Reel Dimensions

Ordering Information

| Model Name | Manufacturing Part Number | Evaluation Kit Part Number |
|---|-------------------------------|----------------------------|
| SKY73032-11 700-1000 MHz Downconversion Mixer | SKY73032-11 (Pb-free package) | TW16-D770 |

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